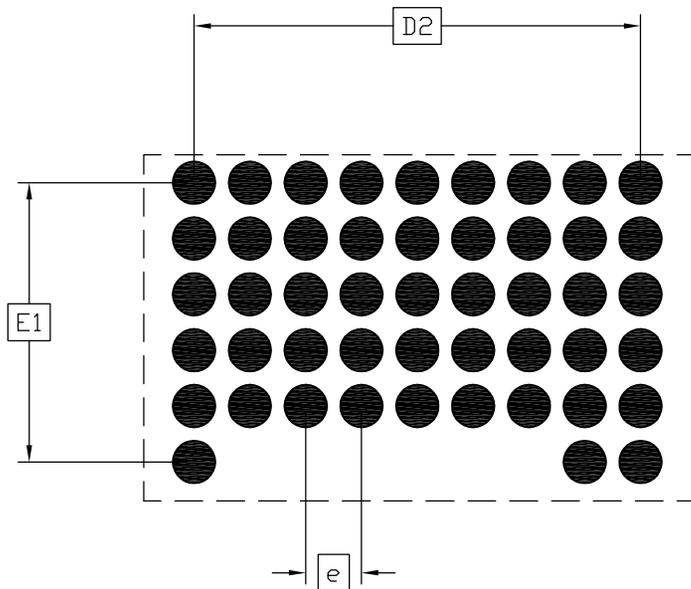
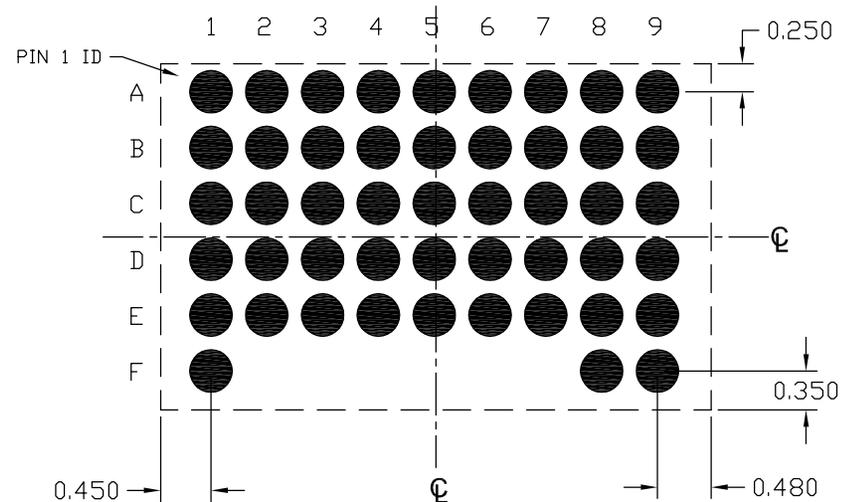


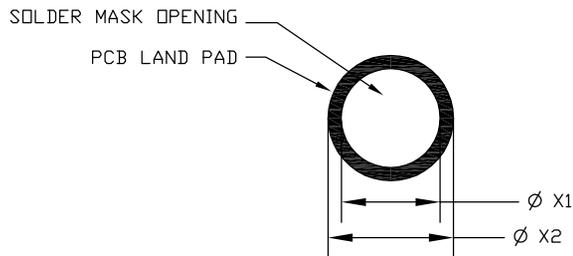
RECOMMENDED LAD PATTERN



PACKAGE OVERLAY



PAD DETAIL INFORMATION



NOTES:

1. REFERENCE PKG. OUTLINE: 21-0942
2. LAND PATTERN COMPLIES TO: IPC7351A.
3. TOLERANCE: +/- 0.02 MM.
4. ALL DIMENSIONS APPLY TO PbFREE (+) PKG. CODE ONLY.
5. ALL DIMENSIONS IN MM.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
D1	4.000 BSC			.157 BSC		
E1	2.500 BSC			.098 BSC		
e	0.500 BSC			.020 BSC		
N	48 BALLS			48 BALLS		
X1	0.230	0.280	0.330	.009	.011	.013
X2	0.355	-	-	.014	-	-

-DRAWING NOT TO SCALE-



TITLE:
PACKAGE LAND PATTERN,
[C484A3+1] WLCSP

APPROVAL

DOCUMENT CONTROL NO.

REV.

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This document (including dimensions, notes & specs) is a recommendation based on typical circuit board manufacturing parameters. Since land pattern design depend on many factors unknown to Maxim (eg. user's board manufacturing specs), user must determine suitability for use.

This document is subject to change without notice.

Contact technical support at <http://www.maximintegrated.com/support> for further questions.